TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

HN3C10FE

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

Two devices are built in to the super-thin and extreme super mini (6pins) package: ES6

MOUNTED DEVICES

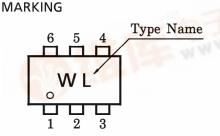
"一工行场PM	Q1/Q2
Three-pins (SSM) mold products are corresponded	2SC5086

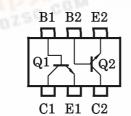
MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	Q1/Q2	UNIT	
Collector-Base Voltage	v_{CBO}	20	V	
Collector-Emitter Voltage	v_{CEO}	12	V	
Emitter-Base Voltage	$V_{ m EBO}$	3	V	
Collector Current	I _C	80	mA	
Base Current	I_{B}	40	mA	
Collector Power Dissipation	P _C (Note 1)	100	mW	
Junction Temperature	T_{j}	125	°C	
Storage Temperature Range	$\mathrm{T}_{\mathrm{stg}}$	-55~125	°C	

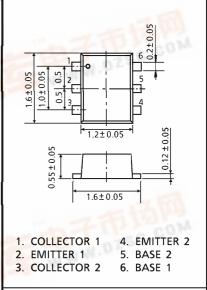
(Note 1): Total power dissipation of Q1 and Q2.

PIN ASSIGNMENT (TOP VIEW)





Unit in mm



JEDEC EIAJ TOSHIBA 2-2N1B

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 10 \text{ V}, I_{E} = 0$		_	1	μ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = 1 \text{ V}, I_{C} = 0$		_	1	μ A
DC Current Gain	${ m h_{FE}}$	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA}$	80	_	240	_
Transition Frequency	${ m f_T}$	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA}$	5	7	_	GHz
Insertion Gain	$ S_{21e} ^2$ (1)	$egin{aligned} { m V_{CE}} &= 10 \ { m V, \ I_{C}} &= 20 \ { m mA,} \ { m f} &= 500 \ { m MHz} \end{aligned}$	1	16.5	_	- dB
	$ S_{21e} ^2$ (2)	$egin{aligned} { m V_{CE}} &= 10 \ { m V, \ I_{C}} &= 20 \ { m mA,} \ { m f} &= 1000 \ { m MHz} \end{aligned}$	8	11.5	_	
Noise Figure	NF (1)	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}, $ f = 500 MHz	_	1	_	- dB
	NF (2)	$egin{aligned} { m V_{CE}} &= 10 \ { m V, \ I_{C}} &= 5 \ { m mA,} \ { m f} &= 1000 \ { m MHz} \end{aligned}$		1.1	2	
Reverse Transfer	$\mathrm{C_{re}}$	$V_{CB} = 10 \text{ V}, I_{E} = 0,$ f = 1 MHz (Note 2)	_	0.7	1.2	рF
Capacitance Q1						
Reverse Transfer Capacitance Q2	$\mathrm{C_{re}}$	$V_{CB} = 10 \text{ V}, I_{E} = 0,$ f = 1 MHz (Note 2)		0.65	1.15	pF

(Note 2): C_{re} is measured by 3 terminal method with capacitance bridge.